Datasheet

ZDB5101 Z-Wave Development Board

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Description:	This datasheet is for the ZM5101 Z Wave SiP Module based ZDB5101 Z-Wave Development Board.
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Approved by:				
Date	CET	Initials	Name	Justification
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REVISION RECORD

Doc. Rev	Date	By	Pages affected	Brief description of changes
3	20170517	MHansen	Table 5	Specified if measurements are radiated or conducted
1D	20140506	slarsen	Figure 3.1, Table 4, p.1, p.10	Removed all references to matching network component as no matching is done on the board. Removed references to EU/US/HK BOM splits. BOMs are identical.
1C	20131122	MVithanage	Figure 4.1	Removed caption
1B	20131119	MVithanage	Figure 3.1, §All, Table 4	Removed 2.4GHz antenna Changed API to variant/library Changed OTP to Flash
1A	20131118	MVithanage	§All	Updated ZM4125 datasheet
2	20180308	BBR	All	Added Silicon Labs template

Table of Contents

Table of Figures

Table of Tables

1 ABBREVIATIONS

Abbreviation	Explanation
D	Differential
EEPROM	Electrically Erasable Programmable Read-Only Memory
HW	Hardware
I	Input
NM	Not Mounted
NVM	Non-Volatile Memory
O	Output
PCB	Printed Circuit Board
SiP	System-in-Package
SMA	Sub-Miniature A
SW	Software
ZDB	Z-Wave Development Board
ZDP	Z-Wave Development Platform

2 INTRODUCTION

2.1 Purpose

The purpose of this datasheet is to describe the ZDB5101 Z-Wave Development Board. The ZDB5101 Z-Wave Development Board contains the highly integrated ZM5101 Z-Wave SiP Module, NVM, HW interface protection circuitry, PCB antennas and a SMA connector for whip antenna mounting.

2.2 Audience and prerequisites

The audience is customers who want to use or evaluate the ZM5101 Z-Wave SiP Module or find inspiration for implementing the ZM5101 on a 4-layer application PCB.

3 ZDB5101 Z-WAVE DEVELOPMENT BOARD

The ZDB5101 Z-Wave Development Board contains the ZM5101 Z-Wave SiP Module, NVM, HW Interface protection circuitry, PCB antennas and a SMA connector for whip antenna mounting. The key components on ZDB5101 are shown in Figure 3.1.
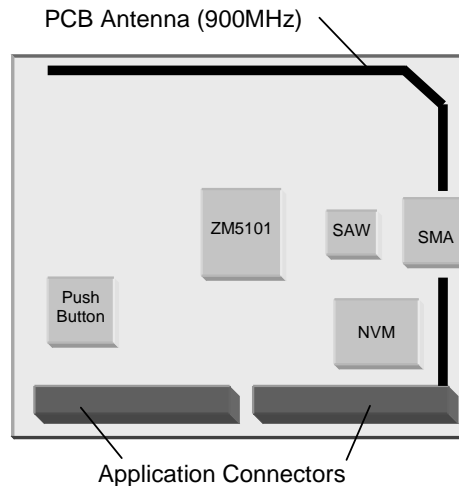
Figure 3.1: ZDB5101 Z-Wave Development Board

3.1 Application Connector Specification

The Application Connectors, J1, J2, on ZDB5101 Z-Wave Development Board are 2x10 2mm pitch pin rows. The signal availability on the application connectors are shown in Table 1.

Table 1: ZDB5101 Application Connector Pin List

ZDB5101 / ZM4125-S		ZDB5101 / ZM4125-S	
J1 no.	**Pin Name**	**J2 no.**	**Pin Name**
1	VPP	1	Ground
2	P2.6-MISO0	2	Ground
3	P3.7-PWM-ADC3-ZEROX-KEYPAD	3	P1.3-Keypad
4	P0.7-KEYPAD	4	P1.7-Keypad
5	P3.6-IRTX2-ADC2-TRIAC-KEYPAD	5	P0.6-Keoad
6	P1.1-INT1-KEYPAD	6	P1.6-Keypad
7	P3.5-IRTX1-ADC1-KEYPAD	7	P0.5-Keypad
8	P2.5-MOSI0	8	P1.5-Keypad
9	USB_DM	9	P0.4-Keypad
10	P2.3-MISO1	10	P1.4-Keypad
11	USB_DP	11	P0.3-Keoad
12	P2.4-SCK1	12	P1.2-Keypad
13	GND	13	P0.2-Keypad
14	P2.2-MOSI1	14	P1.0-INT0-Keypad
15	RESET_N	15	P0.1-Keypad
16	P2.1-TXD0	16	P3.1-IRRX-TXD1-Keypad
17	VCC	17	P0.0-Keypad
18	P2.0-RXD0	18	P3.0
19	P2.7-SCK0	19	NC
20	P3.4-IRTX0-ADC0-KEYPAD	20	NC

Table 2 gives an overview of the communication interfaces, signaling pins, and some ZM5101 HW features available on the application connectors. All GPIOs from ZM5101 are available on application

connectors J1, J2. For a complete list of signals and functionalities available, refer to the ZM5101 Z-Wave SiP Module Datasheet [1].

Table 2: ZDB5101 Z-Wave Development Board Application Connector Layout

Name	Pin#	I/O	Description
+3.3V	J1: 17	Power	Module 3.3V supply input.
ADC[3:0]	 J1: 3 J1: 5 J1: 7 J1: 20	I	Analog-to-Digital Converter input. The ADC is 12/8 bit and can use +3.3V, an internal or an external voltage as reference. ADC3: input ADC2: input ADC1: input/lower reference ADC0: input/higher reference
GND	J1: 13 J2: 1, 2	Power	Ground signal
INT1 INT0	J1: 6 J2: 14	I/O	Interrupt: The signals are level triggered. When in power down mode, the ZDB5101 Z-Wave Development Board's MCU can be woken by asserting the interrupt signal.
P[0.0-0.0], P[1.0-1.7] P[2.0-2.7], P[3.0-3.1] P[3.4-3.7]	Refer to Appendix A for IO pin number	I/O	In/Out: General purpose I/O signal. The IOs may be configured to be work as a keypad matrix.
MISO1[1]	J1: 10	I/O	Master only SPI - Master-In-Slave-Out, and prog interface.
MOSI1[1]	J1: 14	I/O	Master only SPI - Master Out Slave In, and prog interface.
PWM	J1: 3	I	Pulse Width Modulator Output: Used for frequency variation applications.
RESET_N	J1: 15	I	Reset: Active low reset. The ZM5101 Z-Wave SiP Module has an integrated Power-On-Reset and Brown-out detection circuitry.
RXD0	J1: 18	I	UART Receive Data: Supports up to 230.4kbaud.
SCK1[1]	J1: 12	I/O	Master only SPI - SPI Clock, and SPI clock for prog interface.
TRIAC	J1: 5	O	TRIAC Control: A triac controller is implemented in the ZM5101 Z-Wave SiP Module that can control a triac on the Application Module like light dimmer modules etc.
TXD0	J1: 16	O	UART Transmit Data: Supports up to 230.4kbaud.
ZEROX	J1: 3	I	Zero Cross Detection: Used on dimmer modules for detecting 120/240V zero crossing.
VPP	J1: 1	Power	OTP programmable voltage
TXD1	J2: 16	O	UART Transmit Data: Supports up to 230.4kbaud.
MISO0	J1: 2	I/O	Master or slave SPI. Master-In-Slave-Out SPI interface.
MOSI0	J1: 8	I/O	Master or slave SPI. Master Out Slave In SPI interface.
SCK0	J1: 19	I/O	Master or slave SPI. SPI Clock
RXD1	J2: 18	I	UART Receive Data: Supports up to 230.4kbaud.
USB-DM	J1: 9	I/O	USB differential input/output
USB-DP	J1: 11	I/O	USB differential input/output

1. Please note that the SPI interface (MISO, MOSI and SCK) is not available for the Application SW in some Z-Wave protocol variants.

All signals in Table 2 except '+3.3V', 'VCC' and 'GND' are connected through a 1kohm resistor to the ZM5101 Z-Wave SiP Module (U1 in Appendix A).

3.2 SPI Interfaces and NVM

SPI1 interface is used by the protocol in some Z-Wave protocol variants to store routing tables in an external NVM (EEPROM or Flash). The Application SW must _not_ use the SPI1 interface while it is used by the protocol. Table 3 lists the available SW libraries and shows where the Application SW can use SPI1.

Table 3: SW Library / SPI availability

SW Library	External NVM used by Protocol
Routing Slave	No
Enhanced Slave	Yes
Controller	Yes
Static Controller	Yes
Installer	Yes
Bridge	Yes
Portable controller	Yes

P2.5 on ZM5101 Z-Wave SiP Module is the default NVM chip select pin. To assure proper control of the NVM chip select signal during reset and power-up, a pull up resistor on the P2.5 is implemented as shown in Figure 3.2.
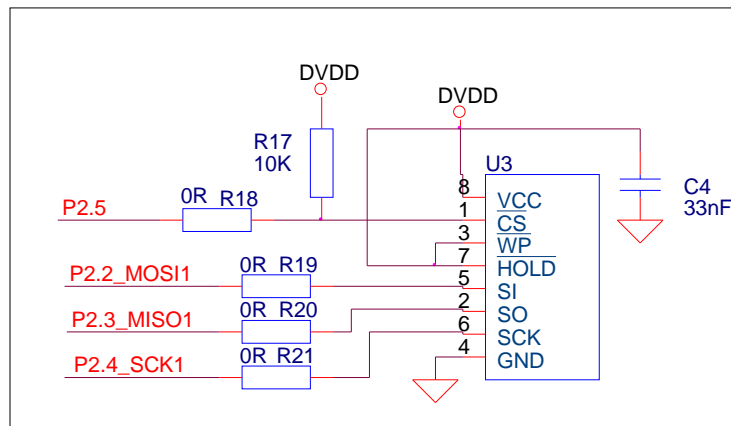
Figure 3.2: External NVM

The protocol data storage occupies only a part of the NVM memory. The required memory space depends on the used Z-Wave protocol variant. The Application SW can use the remaining memory space.

3.3 EMC Noise Reduction

As default, a 1000R@100MHz Ferrite Bead is mounted between the Application Connector '+3.3V' and module '+3.3V' (L3 in Appendix A) to reduce noise from the Application Circuitry.

As default 1000R@100MHz Ferrite Beads are mounted in series with the TRIAC signal and the ZEROX signal (L4 and L5 in Appendix A) to reduce noise from triac circuitry if used for this purpose. Two zero ohm resistors can be mounted instead in applications where TRIAC and ZEROX is not used for power electronic control.

3.4 ZM5101 MCU Specification

Table 4: MCU Specifications

MCU	Description
MCU Type	Optimized 8-bit 8051 MCU core.
MCU speed	32 MHz
Flash Memory	128kbyte. Programmed through the SPI1, UART0, or USB interface.
SRAM	16kbyte
SRAM (CPU)	256byte
RAM (Low power)	128byte (optionally powered in low power state)
MTP Memory	64byte. Non Volatile Data Memory

3.5 RF Specification for ZDB5101 with SAW

Table 5: RF Specifications

RF Parameter	Description
RF data rate	9.6kbps 40kbps 100kbps
Modulation	Frequency Shift Keying (FSK): 9.6kbps and 40kbps Gaussian Frequency Shift Keying (GFSK): 100kbps
Frequency deviation	9.6kbps: Center frequency $\pm$ 20kHz 40kbps: Center frequency $\pm$ 20kHz 100kbps: Center frequency $\pm$ 29kHz
Signal coding	9.6kbps Manchester Encoded 40kbps and 100kbps Non-Return to Zero
Typical RF receiver sensitivity[2]	-103dBm @ 9.6kbps -99dBm @ 40kbps -93dBm @ 100kbps
Typical RF output power[2]	-26dBm to +4dBm
Typical range[1]	Indoor > 40 meters line of sight, in unobstructed environment Outdoor > 100 meters line of sight
RF input/output impedance	50ohm @ respective E/U/H frequencies
RF regulatory	ACMA Compliance CE Compliance FCC Compliance IC Compliance MIC Compliance

1. Test Conditions: ZDB5101 measured radiated with quarter-wavelength monopole antenna mounted on ZDP03A.
2. Test Conditions: ZDB5101 measured conducted at output of SAW filter through on-board SMA.

3.6 Electrical Specification

The "Absolute Maximum Ratings" specifies the conditions in which the ZDB5101 Module is guaranteed not to be damaged but correct operations are not guaranteed. Exceeding the "Absolute Maximum Ratings" may destroy the ZDB5101 Module. See "DC Characteristics" for guaranteed operation limits.

3.6.1 Absolute Maximum Ratings

Table 6: Absolute Maximum Ratings

Electrical	Value
Operating Temperature	-40°C to +85°C
Voltage on input pins	-0.3V to +3.6V
Minimum Operating Voltage ('+3.3V')	+2.3V
Maximum Operating Voltage ('+3.3V')	+3.6V

3.6.2 DC Characteristics

The following DC characteristics are for the ZDB5101 Z-Wave Development Board. DC characteristics related to the ZM5101 are to be found in [1] and are not listed in this datasheet.

Table 7: DC Characteristics (T_A = 25°C, '+3.3V' = 3.3V)

Symbol	Parameter	Condition	Min	Typ	Max	Units
'+3.3V'	Main Supply voltage [1]		2.7	3.3	3.6	V
R_{AC}	Application Connector Serial Resistor	All signals	0.9	1.0	1.1	kΩ
I_C [2]	Continuous Output Current	One GPIO	-8		8	mA
I_{CTOT} [2]	Total continuous output source/sink current	All GPIO	-120		120	mA
I_{CC}	Transmitting [3]	RFPOW Setting: 01 [4] RFPOW Setting: 63 [4]		28 45		mA
	Receiving [5]			32		mA
	Power Down [6]			2		µA
	Programming mode			15		mA
T_{OP}	Operating Temperature		-40		85	°C
H_{OP}	Operating Relative Humidity		8		80	%

(1)   Minimum supply voltage depends on EEPROM/Flash selection. 2.7V is with flash M25PE10.
(2)   If serial 1k ohm resistor is replaced with 0 ohm resistor.
(3)   The transceiver is in transmit mode with the MCU running. The ADC is off.
(4)   Pout available at the SMA connector with SAW filter mounted on ZDB5101.
(5)   The transceiver is in receive mode with the MCU running. The ADC is off.
(6)   Sleep mode, IO ports are powered while MCU, SRAM's, RF transceiver, and ADC are shut down. The chip will wake on brown-out, an external reset pulse, external interrupt (if enabled) and Wake-up timer pulses. Power down current is depending on external memory chip type selected.

3.7 Module Outline

Table 8: Module Dimensions

Physical	Description
Dimension (H x W x D)	8 mm x 54 mm x 47 mm
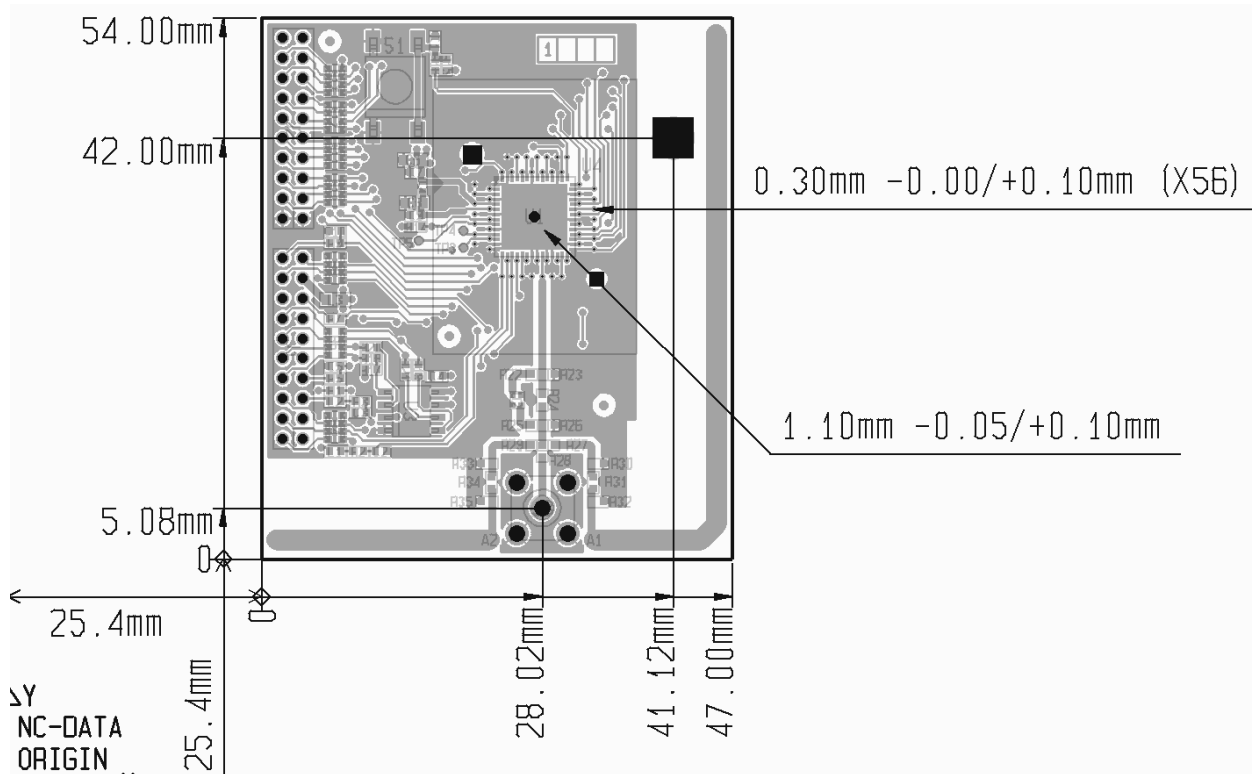
Figure 3.3: ZDB5101 Z-Wave Development Board PCB outline (Top View)

The Application Connector is a standard 2mm pitch 2x10 pin row. The pad hole is a Ø0.9mm plated hole. Metallic objects should be min 10mm from the PCB antenna when mounted on ZDP03A or in a customer based platform. This ensures a good radiation pattern from the antennas.

3.8   Z-Wave Module Component Placement
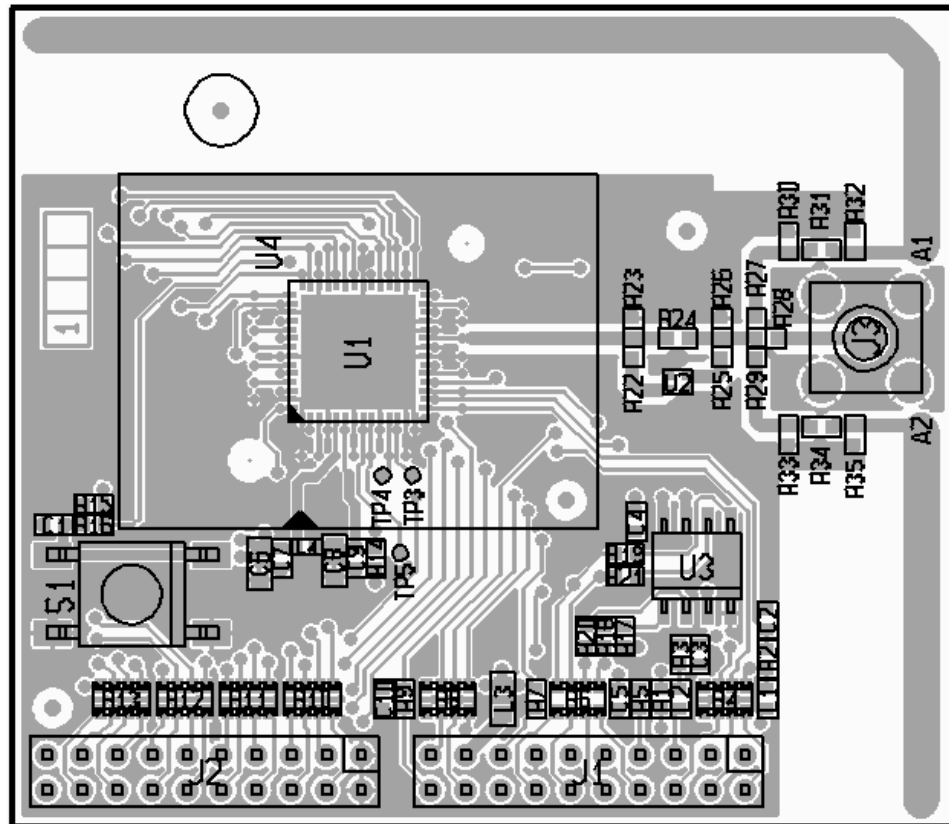
Figure 3.4: ZDB5101 Z-Wave Development Board Component Placement (Top View)

U1 is the ZM5101 Z-Wave SiP Module. U4 is the test socket, which can be mounted on the same PCB, and contain the ZM5101. A1 is the 900MHz antenna, A2 is a higher frequency antenna that is not used. J1 and J2 are application connectors interfacing either to the ZDP03A Z-Wave Development Platform or a customer designed PCB. J1 and J2 contain all GPIOs from the ZM5101 Z-Wave SiP Module.

3.9   Module Naming:

Sigma Designs use the following naming convention:

Z-Wave Module	Z-Wave Development Board

ZMGVSS
        ZM – Z-Wave Module
        G – Z-Wave Generation
        V – Module Variant
        SS – Size in cm^2
 	
e.g.: ZM5101
	ZDBGVSS
	        ZDB – Z-Wave Development Board
	Mounted Module:
	        G – Z-Wave Generation
	        V – Module Variant
	        SS – Size in cm^2
	
	e.g.: ZDB5101

4   REFERENCES

[1]   DSH12625, Datasheet, "ZM5101"
[2]   DSH11243, Datasheet, "ZDP03A, Z-Wave Development Platform"
[3]   APL10045, Application Note, "Antennas for Short Range Devices"

APPENDIX A SCHEMATIC
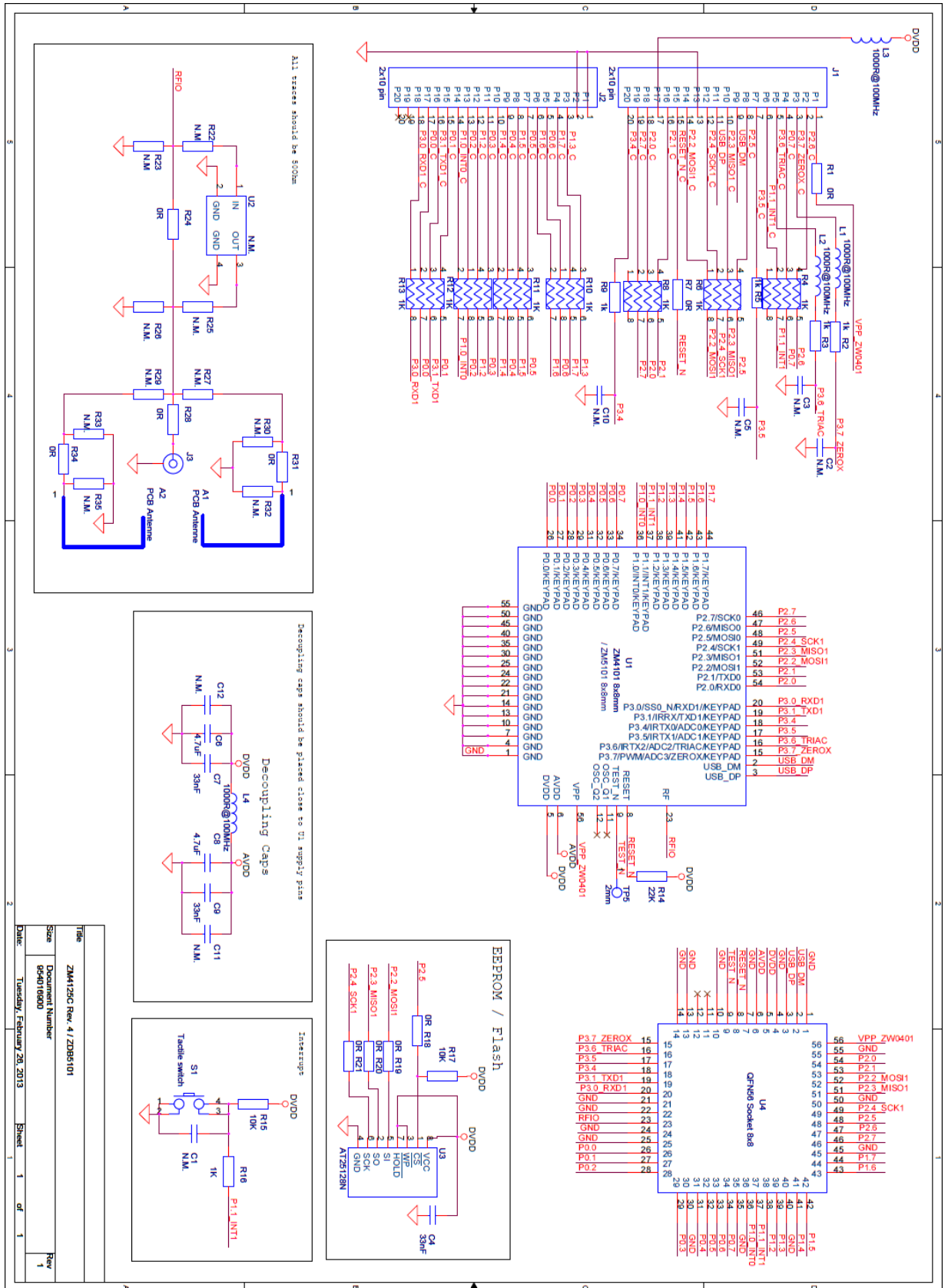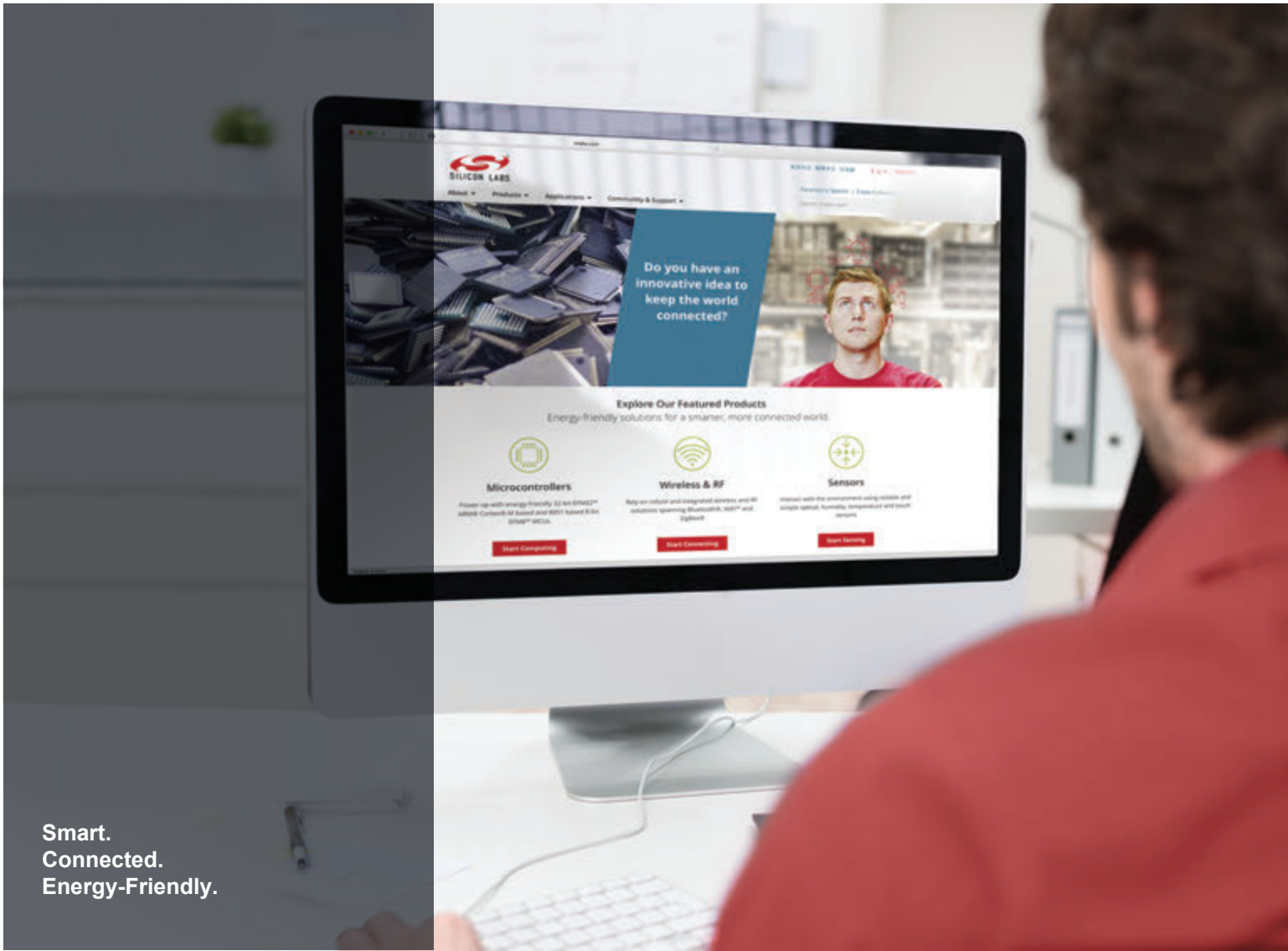
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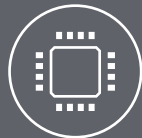
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